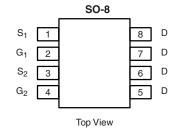


Vishay Siliconix

Complementary MOSFET Half-Bridge (N- and P-Channel)

PRODUCT SUMMARY						
	V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)			
N-Channel	20	0.020 at V _{GS} = 4.5 V	9.1			
		0.030 at V _{GS} = 2.5 V	7.5			
P-Channel	- 20	0.060 at V _{GS} = - 4.5 V	- 5.3			
		0.100 at V _{GS} = - 2.5 V	- 4.1			





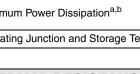
ABSOLUTE MAXIMUM RATINGS $T_A = 25 \text{ °C}$, unless otherwise noted								
Parameter		Symbol	N-Channel		P-Channel			
			10 s	Steady State	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	20		- 20		V	
Gate-Source Voltage		V _{GS}	± 12		± 12			
Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^{a,b}$	T _A = 25 °C	- I _D	9.1	6.6	- 5.3	- 3.8		
	T _A = 70 °C		7.3	5.3	- 4.9	- 3.1		
Pulsed Drain Current		I _{DM}	30		- 20		A	
Continuous Source Current (Diode Conduction) ^{a,b}		۱ _S	2.1	1.1	- 2.1	- 1.1		
Maximum Power Dissipation ^{a,b}	T _A = 25 °C	Р	2.5	1.3	2.5	1.3	w	
	T _A = 70 °C	P _D	1.6	0.8	1.6	0.8		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150				°C		

THERMAL RESISTANCE RATINGS								
			N-Channel		P-Channel			
Parameter		Symbol	Тур.	Max.	Тур.	Max.	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	40	50	41	50		
	Steady State		75	95	75	95	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	20	22	23	26		

Notes:

a. Surface Mounted on FR4 board.

b. $t \le 10$ s.



• Halogen-free According to IEC 61249-2-21 Definition TrenchFET[®] Power MOSFET

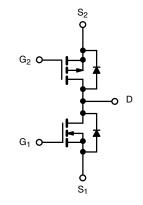
FEATURES

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• Compliant to RoHS Directive 2002/95/EC



HALOGEN FREE Available



lice vollage		*GS		± 12		± 12	
us Drain Current (T 150 °C)ab	T _A = 25 °C	L_	9.1	6.6	- 5.3	- 3.8	
us Drain Current (T _J = 150 °C) ^{a,b}	T _A = 70 °C	I _D	7.3	5.3	- 4.9	- 3.1	1
rain Current		I _{DM}		30		- 20] '
us Source Current (Diode Conductio	n) ^{a,b}	۱ _S	2.1	1.1	- 2.1	- 1.1	
Device Disational b	T _A = 25 °C	P _D	2.5	1.3	2.5	1.3	,
n Power Dissipation ^{a,b}	T _A = 70 °C	U I	1.6	0.8	1.6	0.8	· `
g Junction and Storage Temperature	Range	T _J , T _{stg}		- 55 to 150		0	
MAL RESISTANCE RATI	NGS						
			N-C	hannel	P-0	Channel	
		• • •					

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Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit			
Static		•			•	1			
Cata Thrashald Valtage	V	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	N-Ch	0.6		1.5	v		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	P-Ch	- 0.6		- 1.5	ľ		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$	N-Ch			± 100	nA		
Gale-Dody Leakage			P-Ch			± 100			
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	N-Ch			1	- μΑ		
Zero Gate Voltage Drain Current	1.000	$V_{DS} = -20 V, V_{GS} = 0 V$	P-Ch			- 1			
Zero Gale voltage Diam Current	IDSS	V_{DS} = 20 V, V_{GS} = 0 V, T_{J} = 55 °C	N-Ch			5			
		V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 55 °C	P-Ch			- 5	1		
		$V_{DS} = 5 V, V_{GS} = 4.5 V$	N-Ch	30	30				
On-State Drain Current ^b	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 4.5 V	P-Ch	- 20			A		
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 4.5 V, I _D = 9.1 A	N-Ch		0.016	0.020			
		V _{GS} = - 4.5 V, I _D = - 5.3 A	P-Ch		0.048	0.060			
		V _{GS} = 2.5 V, I _D = 3.3 A	N-Ch		0.024	0.030	Ω		
		V _{GS} = - 2.5 V, I _D = - 1 A	P-Ch		0.082	0.100	1		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 9.1 A	N-Ch		29				
		V _{DS} = - 15 V, I _D = - 5.3 A	P-Ch		11		S		
Diode Forward Voltage ^b	V _{SD}	I _S = 2.1 A, V _{GS} = 0 V	N-Ch		0.8	1.2			
		I _S = - 2.1 A, V _{GS} = 0 V	P-Ch		- 0.8	- 1.2	- V		
Dynamic ^a					L	<u> </u>			
Total Gate Charge	0		N-Ch		11	17			
Iotal Gate Charge	Qg	N-Channel $V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 9.1 \text{ A}$	P-Ch		6.0	9	nC		
Gate-Source Charge	Q _{gs}	$v_{\rm DS} = 10$ v, $v_{\rm GS} = 4.3$ v, $i_{\rm D} = 9.1$ A	N-Ch		2.5				
		P-Channel	P-Ch		1.3				
Gate-Drain Charge	Q _{qd}	V_{DS} = - 10 V, V_{GS} = - 4.5 V, I_{D} = - 5.3 A	N-Ch		3.2				
	9-		P-Ch		1.6	50			
Turn-On Delay Time	t _{d(on)}	N-Channel	N-Ch P-Ch		35 20	50 30	_		
		V_{DD} = 10 V, R_L = 10 Ω	N-Ch		50	80			
Rise Time	t _r	$I_D \cong$ 1 A, V_{GEN} = 10 V, R_g = 6 Ω	P-Ch		35	60			
		P-Channel	N-Ch		31	50			
Turn-Off Delay Time	t _{d(off)}	$V_{DD} = -10 \text{ V}, \text{ R}_{\text{I}} = 10 \Omega$	P-Ch		55	85	ns		
	t _f	$I_D \cong$ - 1 A, V_{GEN} = - 4.5 V, R_q = 6 Ω	N-Ch		15	30			
Fall Time		Ŭ	P-Ch		35	60			
Source-Drain Reverse Recovery Time	e t _{rr} -	I _F = 2.1 A, dl/dt = 100 A/μs	N-Ch		30	60			
Source-Drain Reverse Recovery Time		I _F = - 2.1 A, dl/dt = 100 A/μs	P-Ch	'-Ch	25	50			

Notes:

a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

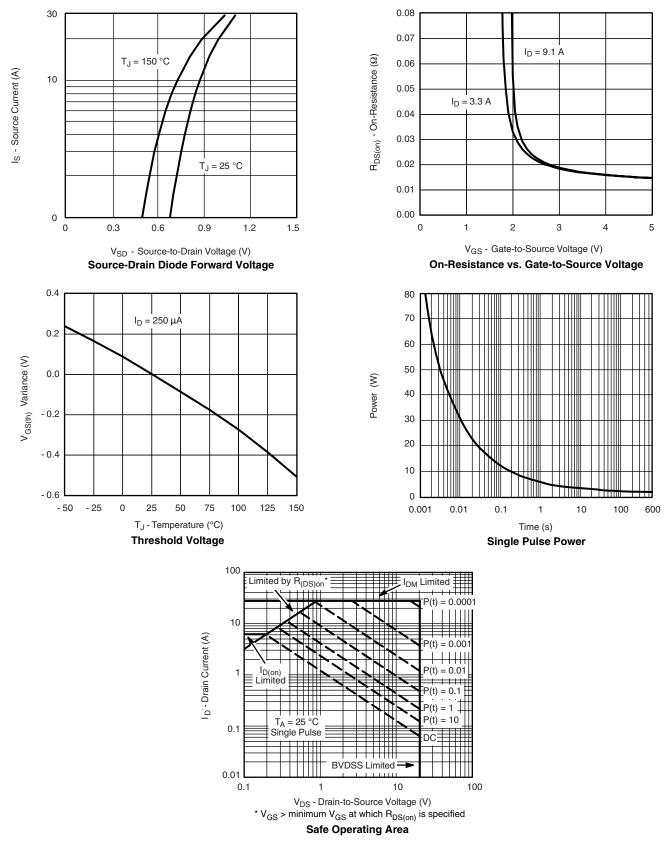
30 30 V_{GS} = 5 V thru 3 V 2.5 V 25 25 ID - Drain Current (A) I_D - Drain Current (A) 20 20 15 15 2 V 10 10 T_C = 125 5 5 25 1.5 V 55 °C 0 0 0 2 3 5 0.5 1 4 0.0 1.0 1.5 2.0 2.5 3.0 V_{DS} - Drain-to-Source Voltage (V) V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics Output Characteristics** 0.08 1600 0.07 1400 Ciss $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ - On-Resistance (Ω) 0.06 1200 C - Capacitance (pF) 0.05 1000 0.04 800 0.03 600 $V_{GS} = 2.5 V$ Coss 0.02 V_{GS} = 4.5 V 400 0.01 200 C_{rss} 0.00 0 0 5 10 15 20 25 30 4 8 0 12 16 20 I_D - Drain Current (A) V_{DS} - Drain-to-Source Voltage (V) **On-Resistance vs. Drain Current** Capacitance 5 1.6 V_{DS} = 10 V $V_{GS} = 4.5 V$ V_{GS} - Gate-to-Source Voltage (V) I_D = 9.1 A 1.4 4 I_D = 9.1 A R_{DS(on)} - On-Resistance (Normalized) 3 1.2 1.0 2 1 0.8 0 0.6 0 2 4 6 8 10 12 - 50 - 25 0 25 50 75 100 125 150 T_J - Junction Temperature (°C) Q_q - Total Gate Charge (nC) Gate Charge **On-Resistance vs. Junction Temperature**

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Si4500BDY

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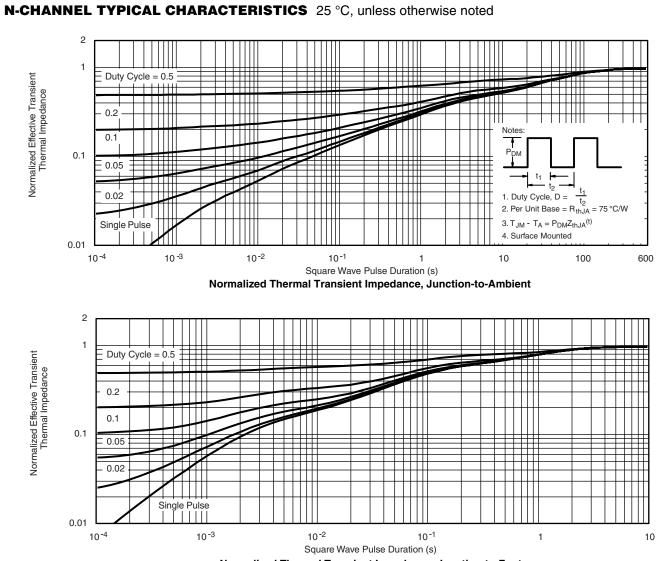
N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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VISHAY

Normalized Thermal Transient Impedance, Junction-to-Foot

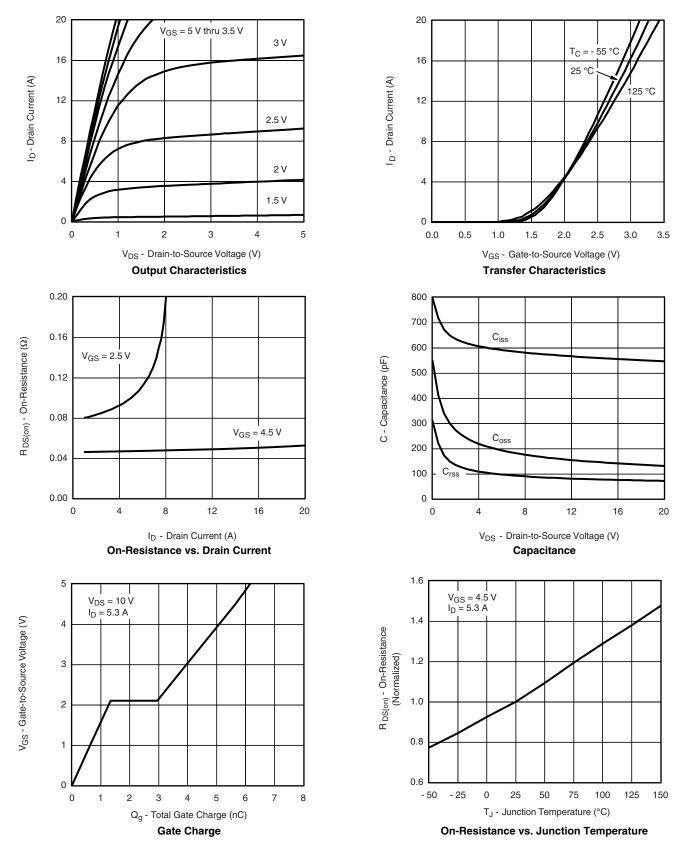
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P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



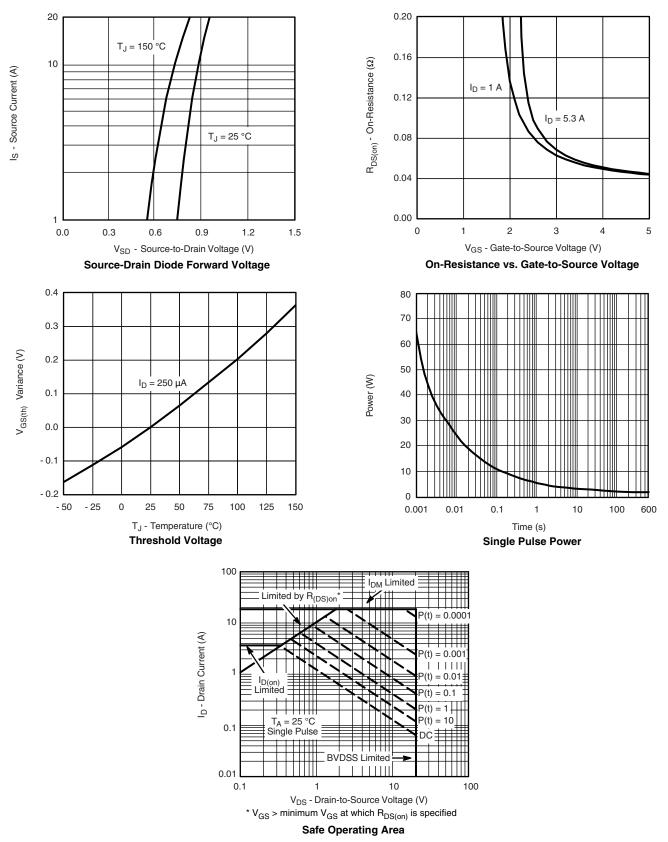
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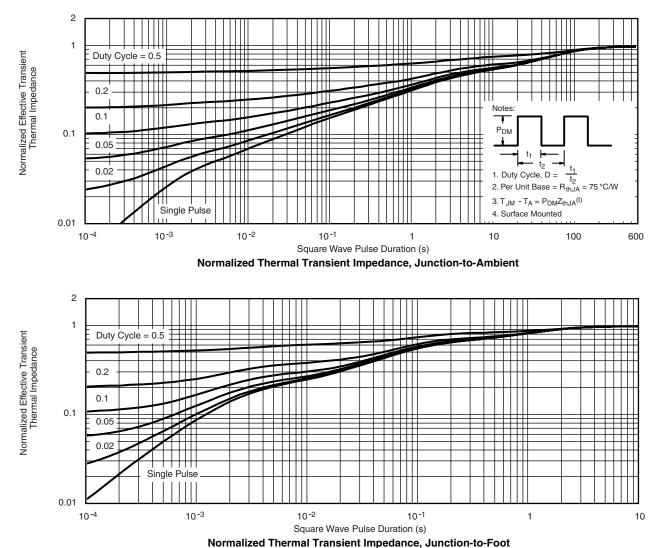
P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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